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Largely enhanced thermal conductivity of graphene/copper composites with highly aligned graphene network

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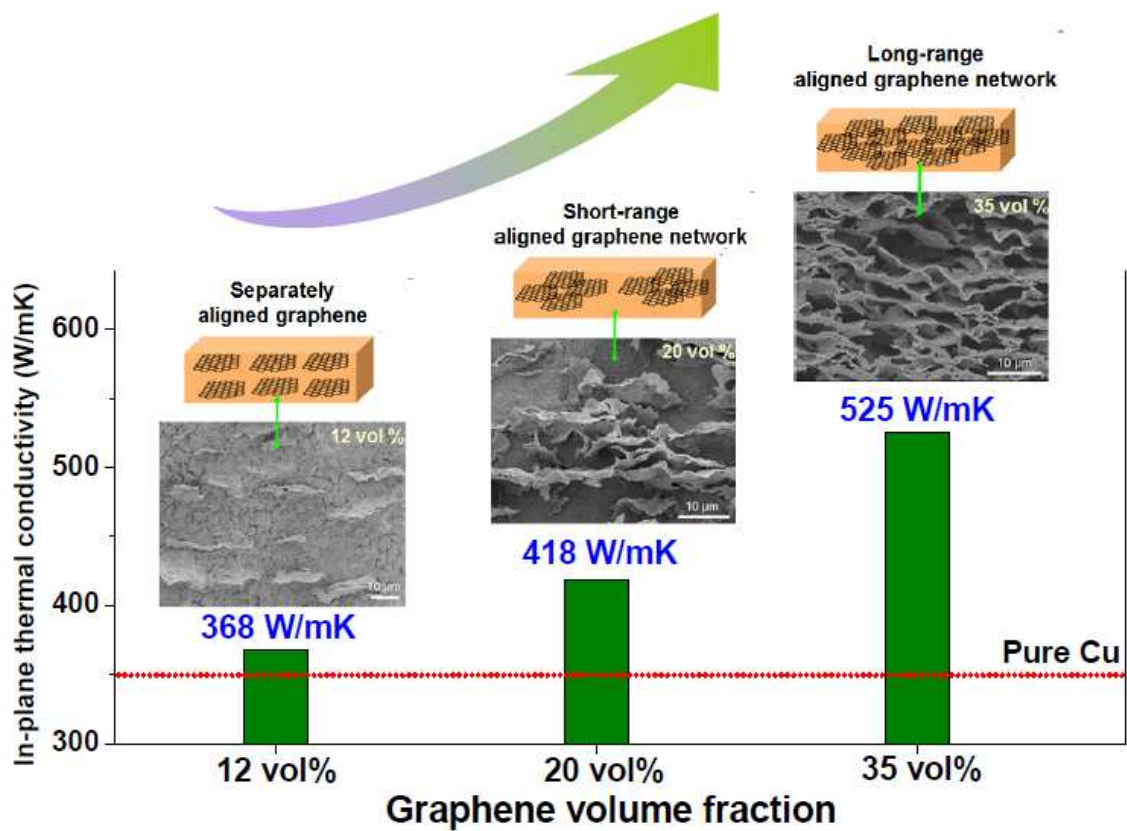
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